# imall

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## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



#### Composite Transistors

### Panasonic

## XP01878

#### Silicon N-channel MOSFET

#### For switching

#### Features

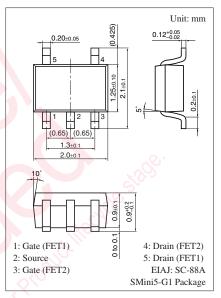
- Two elements incorporated into one package
- Reduction of the mounting area and assembly cost by one half

#### Basic Part Number

• 2SK3539 × 2

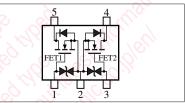
#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

| 0                                | a                |             |      |
|----------------------------------|------------------|-------------|------|
| Parameter                        | Symbol           | Rating      | Unit |
| Drain-source surrender voltage   | V <sub>DSS</sub> | 50          | V    |
| Gate-source voltage (Drain open) | V <sub>GSO</sub> | ±7          | v    |
| Drain current                    | ID               | 100         | mA   |
| Peak drain current               | I <sub>DP</sub>  | 200         | mA   |
| Total power dissipation          | P <sub>T</sub>   | 150         | mW   |
| Channel temperature              | T <sub>ch</sub>  | 150         | °C   |
| Storage temperature              | T <sub>stg</sub> | -55 to +125 | °C   |
|                                  |                  |             |      |



#### Marking Symbol: AL

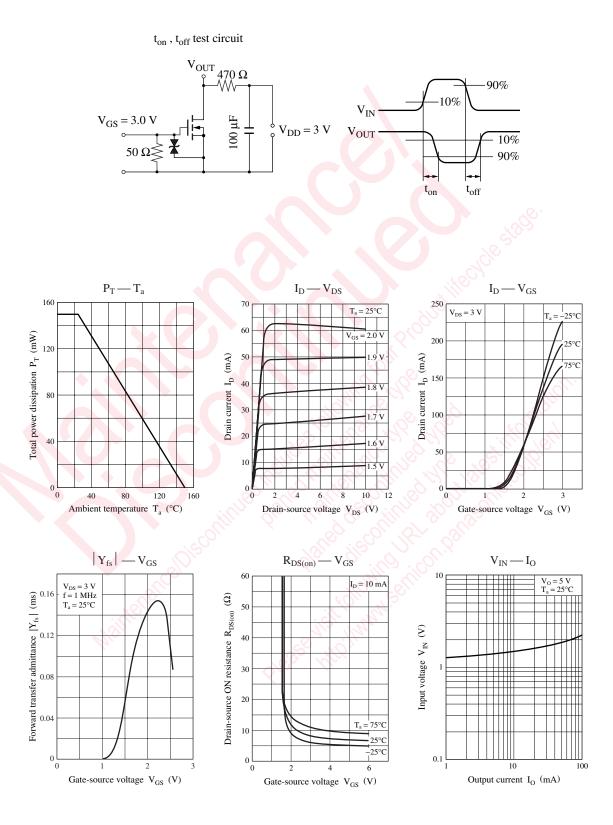
#### Internal Connection



#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

| Parameter   | Symbol              | Conditions   | Min | Тур | Max | Unit |
|---|---------------------|--|-----|-----|-----|------|
| Drain-source surrender voltage                                | VDSS                | $I_{\rm D} = 10 \ \mu A, \ V_{\rm GS} = 0$                     | 50  |     |     | V    |
| Drain-source cutoff current                                   | I <sub>DSS</sub>    | $V_{DS} = 50 V, V_{GS} = 0$                                    |     |     | 1.0 | μΑ   |
| Gate-source cutoff current                                    | I <sub>GSS</sub>    | $V_{GS} = \pm 7 V, V_{DS} = 0$                                 |     |     | ±5  | μΑ   |
| Gate threshold voltage  | V <sub>th</sub>     | $I_D = 1 \ \mu A, \ V_{DS} = 3 \ V$                            | 0.9 | 1.2 | 1.5 | V    |
| Drain-source ON resistance                                    | R <sub>DS(on)</sub> | $I_D = 10 \text{ mA}, V_{GS} = 2.5 \text{ V}$                  |     | 8   | 15  | Ω    |
| N.o.  |                     | $I_D = 10 \text{ mA}, V_{GS} = 4.0 \text{ V}$                  |     | 6   | 12  |      |
| Forward transfer admittance                                   | Y <sub>fs</sub>     | $I_D = 10 \text{ mA}, V_{DS} = 4.0 \text{ V}$                  | 20  | 60  |     | mS   |
| Short-circuit forward transfer capacitance<br>(Common source) | C <sub>iss</sub>    | $V_{DS} = 3 V, V_{GS} = 0 V, f = 1 MHz$                        |     | 12  |     | pF   |
| Short-circuit output capacitance<br>(Common source)           | C <sub>oss</sub>    |  |     | 7   |     | pF   |
| Reverse transfer capacitance<br>(Common source)               | C <sub>rss</sub>    |  |     | 3   |     | pF   |
| Turn-on time *  | t <sub>on</sub>     | $V_{DD}\!=\!3$ V, $V_{GS}\!=\!0$ V to 3 V, $R_L\!=\!470\Omega$ |     | 200 |     | ns   |
| Turn-off time *   | t <sub>off</sub>    | $V_{DD} = 3 V, V_{GS} = 3 V \text{ to } 0 V, R_L = 470 \Omega$ |     | 200 |     | ns   |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors. 2. \*: Refer to t<sub>on</sub> , t<sub>off</sub> test circuit (next page)



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